

RD04HMS2

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

DESCRIPTION

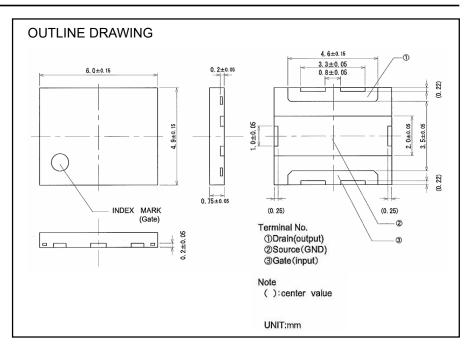
RD04HMS2 of RoHS-compliant product is a MOS FET type transistor specifically designed for VHF/UHF/890-950MHz RF power amplifiers applications.

FEATURES

1.High power gain and High Efficiency Pout=5.0Wtyp, Gp=14dBtyp Drain Effi=58%typ @Vds=12.5V,Pin=0.2W,f=950MHz 2.Integrated gate protection diode

APPLICATION

For output stage of high power amplifiers in VHF/UHF/890-950MHz-band mobile radio sets.



Rohs Compliant

RD04HMS2 is a RoHS compliant product.

ORDERING INFOMATION

ORDER NUMBER	SUPPLY FORM
RD04HMS2-601	Pallet (25pcs/pallet), for evaluation
RD04HMS2-T612	Tape & Reel(2,000pcs/reel)
RD04HMS2-T614	Tape & Reel(4,000pcs/reel)

RD04HMS2

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

ABSOLUTE MAXIMUM RATINGS (Ta=25°C, $Z_G = Z_L = 50\Omega$ UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
VDSS	Drain to source voltage	Vgs=0V	40	V
VGSS	Gate to source voltage	Vds=0V	-5/+10	V
Pch *	Channel dissipation	Tc=25°C	50	W
Pin	Input Power	Zg=Zl=50Ω	0.7	W
ID	Drain Current	-	3	Α
Tch	Junction Temperature	-	150	°C
Tstg	Storage temperature	-	-40 to +125	°C

Note: Above parameters are guaranteed independently.

ELECTRICAL CHARACTERISTICS (Ta=25°C, Z_G=Z_L=50Ω UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
STIVIBUL	PARAMETER	CONDITIONS	MIN	TYP	MAX.	
IDSS	Drain cutoff current	VDS=37V, VGS=0V	-	-	5	uA
IGSS	Gate cutoff current	VGS=10V, VDS=0V	-	-	2.5	uA
VTH	Gate threshold Voltage	VDS=12V, IDS=1mA	1.6	-	2.6	V
Pout1	Output power	f=950MHz*,VDD=12.5V	-	5.0	-	W
ηD1	Drain efficiency	Pin=0.2W,Idq=100mA	-	58	-	%
Pout2	Output power	f=175MHz** ,VDD=12.5V	-	5.5	-	W
ηD2	Drain efficiency	Pin=0.2W,Idq=100mA	-	73	-	%
		V _{DD} =15.2V,Po=4W(Pin Control)				
VSWRT	Load VSWR tolerance	f=135MHz,ldq=100mA,Zg=50Ω	20:1	-	-	VSWR-
		Load VSWR=20:1(All Phase)				

Note: Above parameters, ratings, limits and conditions are subject to change.

THERMAL CHARACTERISTICS (Ta=25°C UNLESS OTHERWISE NOTED)

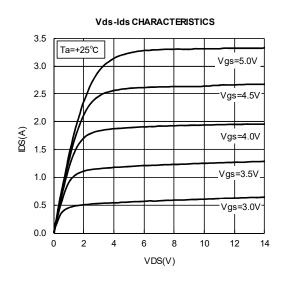
SYMPOL	PARAMETER	CONDITIONS	LIMITS			LINIT
SYMBOL	PARAWETER	CONDITIONS	MIN	TYP	MAX.	UNIT
Rthj-c	Thermal Resistance	Δ VF method	-	1.8	2.5	°C/W

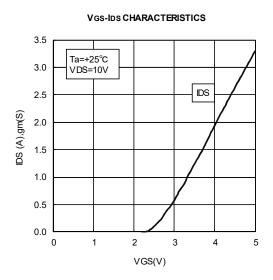
^{*} Theoretical value in case of mounted on infinite heat sink.

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

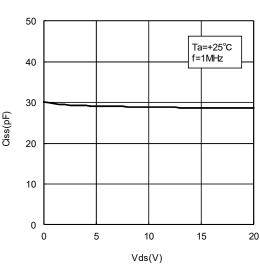
TYPICAL CHARACTERISTICS

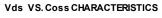
(These are only typical curves and devices are not necessarily guaranteed at these curves.)

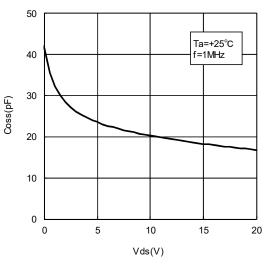




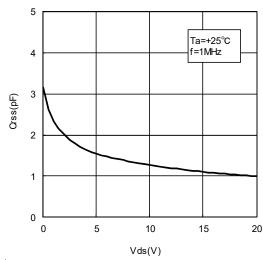








Vds VS. Crss CHARACTERISTICS

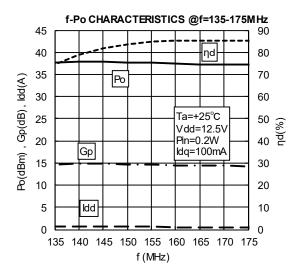


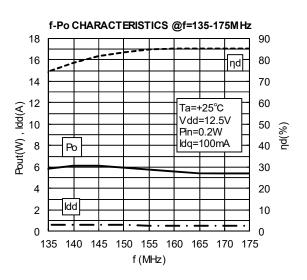
G2K-Si-240405-1

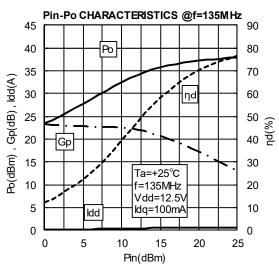
RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

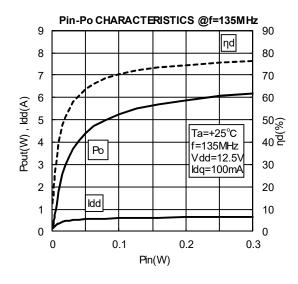
TYPICAL CHARACTERISTICS (135-175MHz)

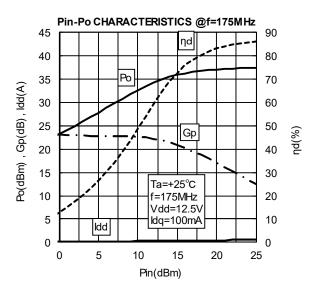
(These are only typical curves and devices are not necessarily guaranteed at these curves.)

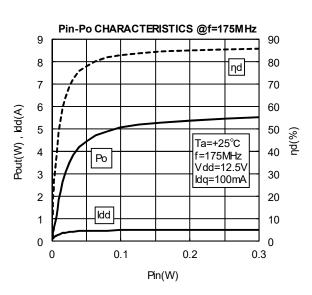










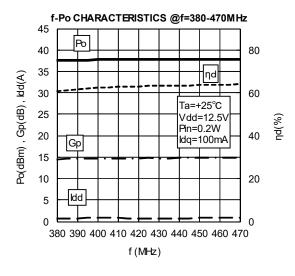


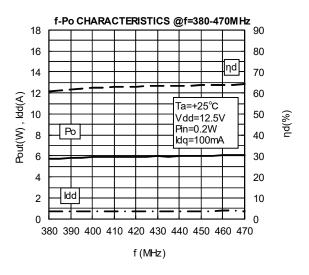
G2K-Si-240405-1

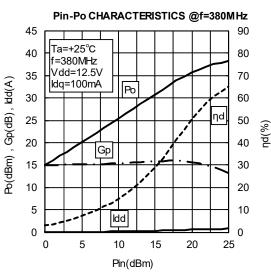
RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

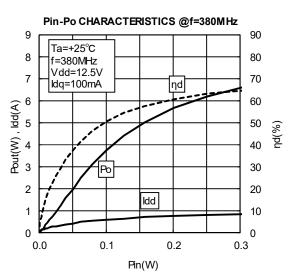
TYPICAL CHARACTERISTICS (380-470MHz)

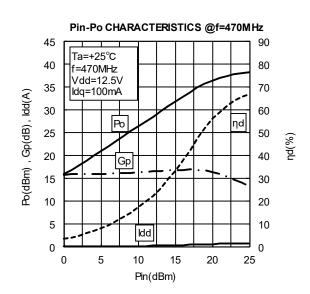
(These are only typical curves and devices are not necessarily guaranteed at these curves.)

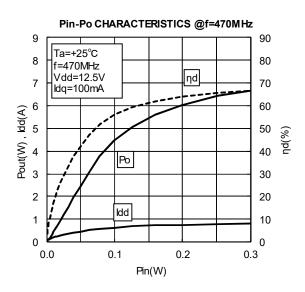










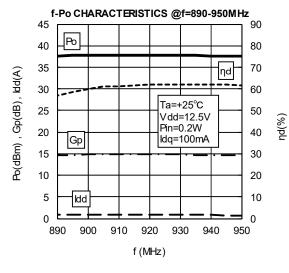


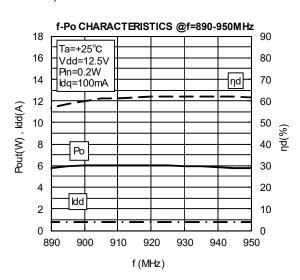
G2K-Si-240405-1

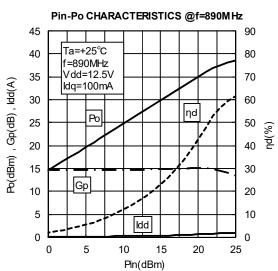
RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

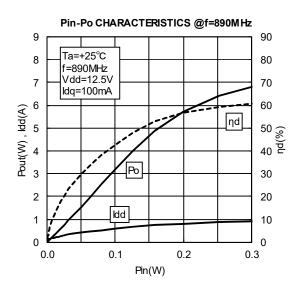
TYPICAL CHARACTERISTICS (890-950MHz)

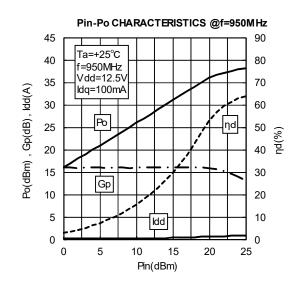
(These are only typical curves and devices are not necessarily guaranteed at these curves.)

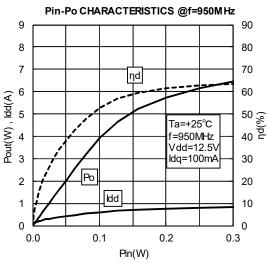






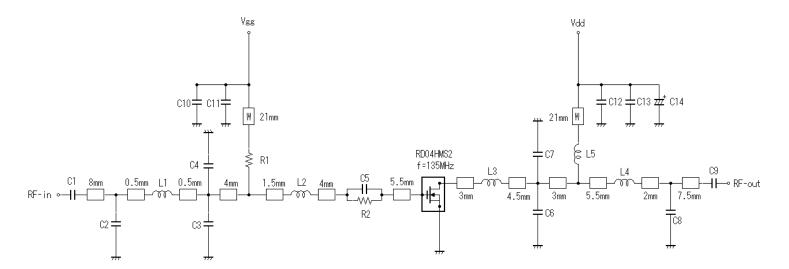






RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

TEST CIRCUIT(f=135-175MHz)



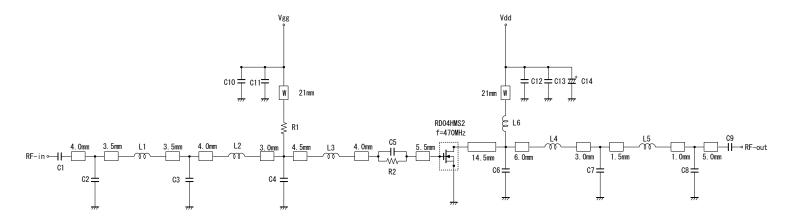
Note:Board material- Glass-Epoxy Substrate
Micro strip line width=1.3mm/500HM,er:4.8,t=0.8mm
W:Line width=1.0mm

```
C<sub>1</sub>
           100pF
                     Chip Ceramic Capacitions
   C2
           27pF
                     Chip Ceramic Capacitions
   C3
                     Chip Ceramic Capacitions
           30pF
   C4
                     Chip Ceramic Capacitions
           30pF
   C<sub>5</sub>
           36pF
                     Chip Ceramic Capacitions
   C<sub>6</sub>
           39pF
                     Chip Ceramic Capacitions
   C7
           39pF
                     Chip Ceramic Capacitions
   C8
           24pF
                     Chip Ceramic Capacitions
   C9
                     Chip Ceramic Capacitions
           100pF
          1000pF
  C10
                     Chip Ceramic Capacitions
                     Chip Ceramic Capacitiors
  C11
          1000pF
                     Chip Ceramic Capacitiors
  C12
          1000pF
  C13
          1000pF
                     Chip Ceramic Capacitions
                       Electrolytic Capacition
  C14
           22µF
   R1
         4.7K OHN
                          Chip Resistors
          47 OHM
   R2
                          Chip Resistors
   L1
          37nH *
                      Enameled wire 7Turns, D:0.43mm, 2.46mmO.D
   L2
          56nH *
                      Enameled wire12Turns, D:0.23mm, 1.66mmO.E
   L3
          22nH *
                      Enameled wire 5Turns, D:0.43mm, 2.46mmO.E
   L4
          29nH *
                      Enameled wire 6Turns, D:0.43mm, 2.46mmO.E
           37nH *
                      Enameled wire 7Turns, D:0.43mm, 2.46mmO.D
* Inductor of Rolling Coil measurement condition: f=100MHz
```

For more information regarding this evaluation board, refer to APPLICATION NOTE "AN-VHF-051"

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

TEST CIRCUIT(f=380-470MHz)



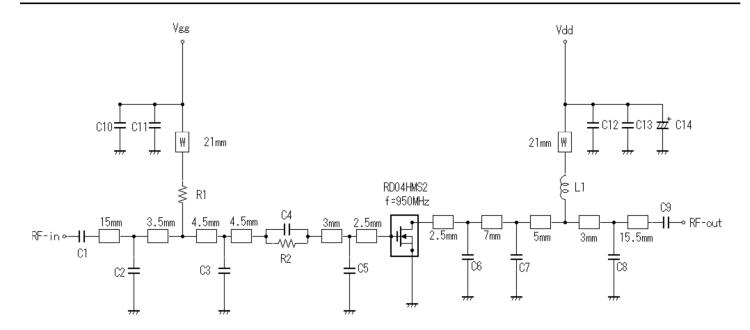
Note:Board material- Glass-Epoxy Substrate Micro strip line width=1.3mm/500HM, er:4.8, t=0.8mm W:Line width=1.0mm

C2 6pF Chip Ceramic Capacitors C4 36pF Chip Ceramic Capacitors C5 24pF Chip Ceramic Capacitors C6 36pF Chip Ceramic Capacitors C6 36pF Chip Ceramic Capacitors C7 20pF Chip Ceramic Capacitors C8 7pF Chip Ceramic Capacitors C9 100pF Chip Ceramic Capacitors C10 1000pF Chip Ceramic Capacitors C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Electrolytic Capacitor C15 27 Chip Ceramic Capacitors C16 2000pF Chip Ceramic Capacitors C17 Chip Ceramic Capacitors C18 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C11 Ceramic Capacitors C12 Chip Ceramic Capacitors C13 Chip Ceramic Capacitors C14 Ceramic Capacitors C15 Chip Ceramic Capacitors C16 Chip Ceramic Capacitors C17 Chip Ceramic Capacitors C18 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C11 Ceramic Capacitors C12 Chip Ceramic Capacitors C13 Ceramic Capacitors C14 Ceramic Capacitors C15 Chip Ceramic Capacitors C16 Ceramic Capacitors C17 Chip Ceramic Capacitors C18 Ceramic Capacitors C19 Ceramic Capacitors C10 Ceramic Capacitors C10 Ceramic Capacitors C11 Ceramic Capacitors C12 Ceramic Capacitors C12 Ceramic Capacitors C13 Ceramic Capacitors C14 Ceramic Capacitors C15 Ceramic Capacitors C16 Ceramic Capacitors C17 Ceramic Capacitors C10 Ceramic Capacitors C12 Ceramic	C1	100pF	Chip Ceramic Capacitors
C4 36pF Chip Ceramic Capacitors C5 24pF Chip Ceramic Capacitors C6 36pF Chip Ceramic Capacitors C7 20pF Chip Ceramic Capacitors C8 7pF Chip Ceramic Capacitors C9 100pF Chip Ceramic Capacitors C10 1000pF Chip Ceramic Capacitors C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Chip Ceramic Capacitors C15 4.7K OHV C16 Ceramic Capacitor C17 Chip Ceramic Capacitors C18 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C11 Ceramic Capacitors C12 Chip Ceramic Capacitor C13 Ceramic Capacitors C14 Ceramic Capacitors C15 Chip Ceramic Capacitors C16 Ceramic Capacitors C17 Ceramic Capacitors C18 Ceramic Capacitors C19 Ceramic Capacitors C19 Ceramic Capacitors C10 Ceramic Capacitors C10 Ceramic Capacitors C11 Ceramic Capacitors C12 Ceramic Capacitors C13 Ceramic Capacitors C14 Ceramic Capacitors C15 Ceramic Capacitors C16 Ceramic Capacitors C17 Ceramic Capacitors C18 Ceramic Capacitors C19 Ceramic Capacitors C19 Ceramic Capacitors C10 Ceramic Capacitors C10 Ceramic Capacitors C11 Ceramic Capacitors C12 Ceramic Capacitors C12 Ceramic Capacitors C13 Ceramic Capacitors C14 Ceramic Capacitors C15 Ceramic Capacitors C16 Ceramic Capacitors C17 Ceramic Capacitors C19 Ceramic Capacitors C10 Ceramic Capacitors C10 Ceramic Capacitors C10 Ceramic Capacitors C11 Ceramic Capacitors C12 Ceramic Capacitors C12 Ceramic Capacitors C13 Ceramic Capacitors C14 Ceramic Capacitors C15 Ceramic Capacitors C16 Ceramic Capacitors C17 Ceramic Capacitors C19 Ceramic Capacitors C10 Ceramic Capacitors C10 Ceramic Capacitors C10 Ceramic Capacitors C11 Ceramic Capacitors C12 Ceramic Capacitors C12 Ceramic Capacitors C12 Ceramic Capacitors C14 Ceramic Capacitors C15 Ceramic Capacitors C16 Ceramic Capacitors C17 Ceramic Capacitors C19 Ceramic Capacitors C10 Ceramic Capacitors C10 Ceramic Capacitors C11 Ceramic Capacitors C12 Ceramic Capacitors C12 Ceramic Capacitors C12 Ceramic Capacitors C13 Ceramic Capacitors C14 Ceramic Capacitors C15 Ceramic Capacitors C16 C	C2	6pF	Chip Ceramic Capacitors
C5 24pF Chip Ceramic Capacitors C6 36pF Chip Ceramic Capacitors C7 20pF Chip Ceramic Capacitors C8 7pF Chip Ceramic Capacitors C9 100pF Chip Ceramic Capacitors C10 1000pF Chip Ceramic Capacitors C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Chip Ceramic Capacitors C15 4.7K OHN Chip Resistors C16 4.7K OHN Chip Resistors C17 Chip Resistors C18 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C11 Capacitor C12 Chip Resistors C12 Chip Resistors C13 Chip Resistors C14 Capacitor C15 Chip Ceramic Capacitors C16 Chip Ceramic Capacitors C17 Chip Ceramic Capacitors C18 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C11 Capacitors C12 Chip Ceramic Capacitors C13 Capacitors C14 Capacitors C15 Chip Ceramic Capacitors C16 Chip Ceramic Capacitors C17 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C11 Capacitors C12 Chip Ceramic Capacitors C13 Capacitors C14 Capacitors C15 Chip Ceramic Capacitors C16 Chip Ceramic Capacitors C17 Chip Ceramic Capacitors C18 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C11 Chip Ceramic Capacitors C12 Chip Ceramic Capacitors C13 Chip Ceramic Capacitors C14 Chip Ceramic Capacitors C15 Chip Ceramic Capacitors C16 Chip Ceramic Capacitors C17 Chip Ceramic Capacitors C18 Chip Ceramic Capacitors C19 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C12 Chip Ceramic Capacitors C13 Chip Ceramic Capacitors C14 Chip Ceramic Capacitors C15 Chip Ceramic Capacitors C16 Chip Ceramic Capacitors C17 C	C3	20pF	Chip Ceramic Capacitors
C6 36pF Chip Ceramic Capacitors C7 20pF Chip Ceramic Capacitors C8 7pF Chip Ceramic Capacitors C9 100pF Chip Ceramic Capacitors C10 1000pF Chip Ceramic Capacitors C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Chip Ceramic Capacitors C15 12nH* Chip Resistors C1 12nH* Chip Resistors C1 12nH* Enameled wire 3Turns, D:0.23mm, 1.66mmO.D C1 12nH* Enameled wire 2Turns, D:0.23mm, 1.66mmO.D	C4	36pF	Chip Ceramic Capacitors
C7 20pF Chip Ceramic Capacitors C8 7pF Chip Ceramic Capacitors C9 100pF Chip Ceramic Capacitors C10 1000pF Chip Ceramic Capacitors C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Chip Ceramic Capacitors C15 1000pF Chip Ceramic Capacitors C16 22µF Chip Ceramic Capacitors C17 Chip Ceramic Capacitors C18 CHIP Ceramic Capacitors C19 CHIP Ceramic Capacitors C19 CHIP Ceramic Capacitors C10 CHIP Ceramic Capacitors C10 CHIP Ceramic Capacitors C11 Capacitors C12 CHIP Ceramic Capacitors C13 CHIP Ceramic Capacitors C14 Capacitors C15 CHIP Ceramic Capacitors C16 CHIP Ceramic Capacitors C17 CHIP Ceramic Capacitors C18 CHIP CERAMIC CAPACITORS C19 CHIP CERAMIC CAPACITORS C19 CHIP CERAMIC CAPACITORS C10 CAPACITORS C10 CHIP CERAMIC CAPACITORS C11 CHIP C	C5	24pF	Chip Ceramic Capacitors
C8 7pF Chip Ceramic Capacitors C9 100pF Chip Ceramic Capacitors C10 1000pF Chip Ceramic Capacitors C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Electrolytic Capacitor C15 4.7K OHV Chip Resistors C16 47 OHM Chip Resistors C17 Enameled wire 3Turns, D:0.23mm, 1.66mmO.D C18 Enameled wire 2Turns, D:0.23mm, 1.66mmO.D C19 Enameled wire 4Turns, D:0.23mm, 1.66mmO.D C10 Enameled wire 4Turns, D:0.23mm, 1.66mmO.D C10 Enameled wire 4Turns, D:0.23mm, 1.66mmO.D	C6	36pF	Chip Ceramic Capacitors
C9 100pF Chip Ceramic Capacitors C10 1000pF Chip Ceramic Capacitors C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Electrolytic Capacitor C15 4.7K OHV Chip Resistors C16 47 OHM Chip Resistors C17 2000pF Chip Ceramic Capacitor C18 22µF Electrolytic Capacitor C19 Chip Resistors C10 1000pF Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Chip Ceramic Capacitors C11 Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 Capacitors C15 Electrolytic Capacitors C16 Chip Ceramic Capacitors C17 Chip Ceramic Capacitors C18 Chip Ceramic Capacitors C19 Chip Ceramic Capacit	C7	20pF	Chip Ceramic Capacitors
C10 1000pF Chip Ceramic Capacitors C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Electrolytic Capacitor C15 4.7K OHV Chip Resistors C16 47 OHM Chip Resistors C17 4.7K OHM Chip Resistors C18 47 OHM Chip Resistors C19 Chip Resistors C19 Chip Ceramic Capacitor C19 Ceramic Capacitors C10 Chip Ceramic Capacitors C10 Ceramic Capacitors C10 Chip Ceramic Cap	C8	7pF	Chip Ceramic Capacitors
C11 22000pF Chip Ceramic Capacitors C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Electrolytic Capacitor R1 4.7K OHV Chip Resistors R2 47 OHM Chip Resistors L1 12nH * Enameled wire 3Turns, D:0.23mm, 1.66mmO.D L2 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	C9	100pF	Chip Ceramic Capacitors
C12 1000pF Chip Ceramic Capacitors C13 22000pF Chip Ceramic Capacitors C14 22µF Electrolytic Capacitor R1 4.7K OHV Chip Resistors R2 47 OHM Chip Resistors L1 12nH * Enameled wire 3Turns, D:0.23mm, 1.66mmO.D L2 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	C10	1000pF	Chip Ceramic Capacitors
C13 22000pF Chip Ceramic Capacitors C14 22µF Electrolytic Capacitor R1 4.7K OHV Chip Resistors R2 47 OHM Chip Resistors L1 12nH * Enameled wire 3Turns, D:0.23mm, 1.66mmO.D L2 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	C11	22000pF	Chip Ceramic Capacitors
C14 22µF Electrolytic Capacitor R1 4.7K OHV R2 47 OHM Chip Resistors L1 12nH * Enameled wire 3Turns, D:0.23mm, 1.66mmO.D L2 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	C12	1000pF	Chip Ceramic Capacitors
R1 4.7K OHV R2 47 OHM Chip Resistors Chip Resistors Chip Resistors Chip Resistors L1 12nH * Enameled wire 3Turns, D:0.23mm, 1.66mmO.D L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	C13	22000pF	Chip Ceramic Capacitors
R2 47 OHM Chip Resistors L1 12nH * Enameled wire 3Turns, D:0.23mm, 1.66mmO.D L2 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	C14	22µF	Electrolytic Capacitor
L1 12nH * Enameled wire 3Turns, D:0.23mm, 1.66mmO.D L2 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	R1	4.7K OHN	Chip Resistors
L2 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	R2	47 OHM	Chip Resistors
L3 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	L1	12nH *	Enameled wire 3Turns, D:0.23mm, 1.66mmO.D
L4 8nH * Enameled wire 2Turns, D:0.23mm, 1.66mmO.D L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	L2	8nH *	Enameled wire 2Turns, D:0.23mm, 1.66mmO.D
L5 16nH * Enameled wire 4Turns, D:0.23mm, 1.66mmO.D L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	L3	8nH *	Enameled wire 2Turns, D:0.23mm, 1.66mmO.D
L6 37nH * Enameled wire 7Turns, D:0.43mm, 2.46mmO.D	L4	8nH *	Enameled wire 2Turns, D:0.23mm, 1.66mmO.D
	L5	16nH *	Enameled wire 4Turns, D:0.23mm, 1.66mmO.D
* Inductor of Rolling Coil measurement condition : f=100MHz	L6	37nH *	Enameled wire 7Turns, D:0.43mm, 2.46mmO.D
madeter of reming con moderness containers in recommiz	* Inducto	or of Rolling C	Coil measurement condition : f=100MHz

For more information regarding this evaluation board, refer to APPLICATION NOTE "AN-UHF-114"

TEST CIRCUIT(f=890-950MHz)

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W



Note:Board material- Glass-Epoxy Substrate Micro strip line width=1.3mm/500HM,er:4.8,t=0.8mm W:Line width=1.0mm

C1	150pF	Chip Ceramic Capacitiors
C2	4pF	Chip Ceramic Capacitiors
C3	9pF	Chip Ceramic Capacitiors
C4	16pF	Chip Ceramic Capacitiors
C5	10pF	Chip Ceramic Capacitiors
C6	12pF	Chip Ceramic Capacitiors
C7	5pF	Chip Ceramic Capacitiors
C8	4pF	Chip Ceramic Capacitiors
C9	150pF	Chip Ceramic Capacitiors
C10	100pF	Chip Ceramic Capacitiors
C11	1000pF	Chip Ceramic Capacitiors
C12	100pF	Chip Ceramic Capacitiors
C13	1000pF	Chip Ceramic Capacitiors
C14	22µF	Electrolytic Capacitior
R1	4.7K OHN	Chip Resistors
R2	33 OHM	Chip Resistors
L1	37nH *	Enameled wire 7Tums, D:0.43mm, 2.46mmO.D
In ducate	r of Dolling	Cail magazinamant condition : £ 100MI

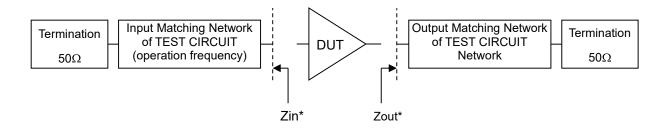
* Inductor of Rolling Coil measurement condition : f=100MHz

For more information regardi

ng this evaluation board, refer to APPLICATION NOTE "AN-900-043"

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

Input / Output Impedance VS. Frequency Characteristics Method of Measurement



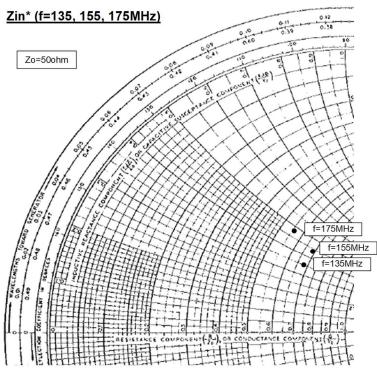
Zin*: Input Matching Network impedance measured from DUT

Zout*: Output Matching Network impedance measured from DUT

Z0: Characteristic impedance

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

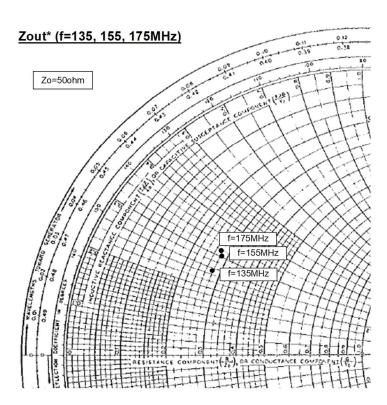
Input / Output Impedance VS. Frequency Characteristics



@Pin=0.2W, Vds=12.5V,Idq=0.1A

f	Zin*
(MHz)	(ohm)
	34.15 + j 17.78
155	34.90 + j 21.74
175	28.10 + j 24.30

Zin*: Complex conjugate of intput impedance



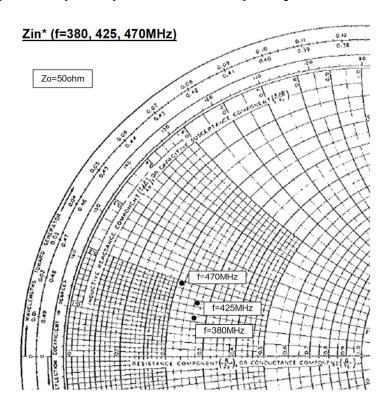
@Pin=0.2W, Vds=12.5V,Idq=0.1A

f	Zout*
(MHz)	(ohm)
135	14.18 + j 12.41
155	14.45 + j 15.35
175	13.90 + j 15.87

Zout*: Complex conjugate of output impedance

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

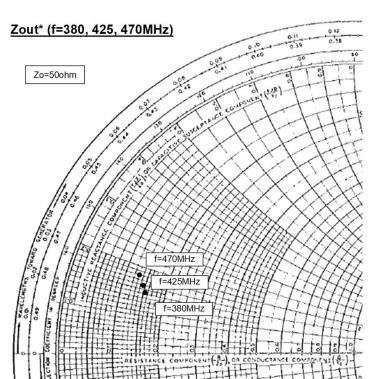
Input / Output Impedance VS. Frequency Characteristics



@Pin=0.2W, Vds=12.5V,Idq=0.1A

f	Zin*
(MHz)	(ohm)
380	13.33 + j 5.61
425	13.49 + j 7.55
470	10.39 + j 9.64

Zin*: Complex conjugate of intput impedance



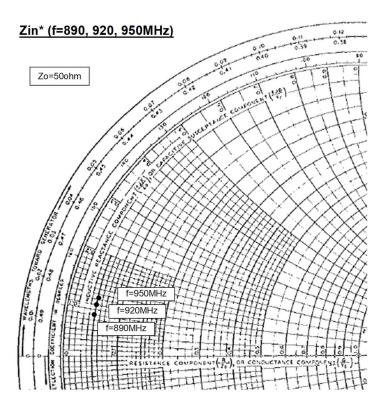
@Pin=0.2W, Vds=12.5V,Idq=0.1A

f	Zout*
(MHz)	(ohm)
380	7.83 + j 7.20
425	7.35 + j 7.93
470	6.32 + j 8.95

Zout*: Complex conjugate of output impedance

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

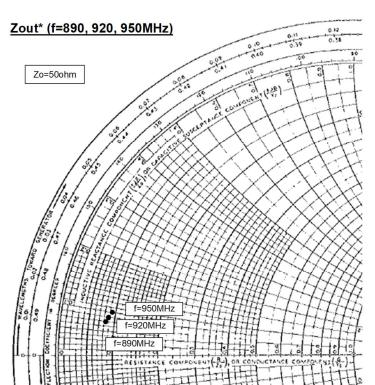
Input / Output Impedance VS. Frequency Characteristics



@Pin=0.2W, Vds=12.5V,Idq=0.1A

f	Zin*
(MHz)	(ohm)
890	2.59 + j 3.87
920	2.60 + j 4.81
950	2.67 + j 5.69

Zin*: Complex conjugate of intput impedance



@Pin=0.2W, Vds=12.5V,Idq=0.1A

f	Zout*
(MHz)	(ohm)
890	4.19 + j 3.38
920	4.47 + j 3.99
950	4.83 + j 4.52

Zout*: Complex conjugate of output impedance

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

RD04HMS2 S-PARAMETER DATA (@Vdd=12.5V, ldq=100mA)

Freq.	S11		S21		S12		S22	
[MHz]	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
100	0.819	-119.5	18.918	101.5	0.027	12.3	0.582	-106.0
135	0.807	-131.6	14.510	90.5	0.028	1.7	0.589	-117.4
150	0.807	-135.2	13.103	86.7	0.027	-1.9	0.596	-120.8
175	0.810	-140.1	11.184	81.1	0.027	-7.1	0.612	-125.3
200	0.816	-143.9	9.668	76.1	0.027	-11.6	0.630	-129.0
250	0.831	-149.5	7.468	67.8	0.025	-19.2	0.669	-134.5
300	0.847	-153.5	5.950	60.8	0.024	-25.6	0.707	-138.8
350	0.863	-156.7	4.855	54.8	0.022	-30.9	0.741	-142.4
400	0.877	-159.3	4.032	49.6	0.021	-35.3	0.772	-145.6
450	0.890	-161.6	3.397	44.9	0.019	-39.3	0.798	-148.4
500	0.901	-163.5	2.897	40.8	0.018	-42.6	0.821	-150.9
520	0.905	-164.2	2.727	39.3	0.017	-43.7	0.829	-151.8
550	0.911	-165.3	2.497	37.2	0.016	-45.3	0.840	-153.2
600	0.919	-166.9	2.174	33.9	0.015	-47.9	0.857	-155.3
650	0.927	-168.3	1.911	30.9	0.014	-49.9	0.871	-157.2
700	0.933	-169.7	1.693	28.1	0.013	-51.6	0.884	-158.9
750	0.938	-170.9	1.509	25.5	0.011	-53.1	0.894	-160.6
800	0.943	-172.1	1.354	23.1	0.010	-54.2	0.904	-162.2
850	0.947	-173.2	1.221	20.8	0.009	-55.1	0.912	-163.7
900	0.950	-174.3	1.108	18.7	0.008	-55.6	0.918	-165.1
941	0.953	-175.1	1.028	17.1	0.008	-55.7	0.923	-166.2
950	0.953	-175.3	1.009	16.7	0.008	-55.7	0.924	-166.5
1000	0.956	-176.3	0.924	14.8	0.007	-55.4	0.929	-167.8

G2K-Si-240405-1

RD04HMS2

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

ATTENTION:

- 1.High Temperature; This product might have a heat generation while operation, Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product, do not place the combustible material that have possibilities to arise the fire.
- 2.Generation of High Frequency Power; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
- 3.Before use; Before use the product, Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

- 1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
- 2.RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and In the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products, please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.
- 3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
- 4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
- 5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of Tchmax=150deg/C) ,140deg/C(in case of Tchmax=175deg/C) under standard conditions.
- 6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
- 7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
- 8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
- 9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.

RD04HMS2

RoHS Compliant, Silicon MOSFET Power Transistor, 175MHz, 950MHz, 4W

- 10. Please avoid use in the place where water or organic solvents can adhere directly to the product and the environments with the possibility of caustic gas, dust, salinity, etc. Reliability could be markedly decreased and also there is a possibility failures could result causing a serious accident. Likewise, there is a possibility of causing a serious accident if used in an explosive gas environment. Please allow for adequate safety margin in your designs.
- 11. Please refer to the additional precautions in the formal specification sheet.

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

- •These materials are intended as a reference to assist our customers in the selection of the Mitsubishi semiconductor product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Mitsubishi Electric Corporation or a third party.
- •Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
- •All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Mitsubishi Electric Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for the latest product information before purchasing a product listed herein.
- The information described here may contain technical inaccuracies or typographical errors. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
- Please also pay attention to information published by Mitsubishi Electric Corporation by various means, including the Mitsubishi Semiconductor home page (http://www.MitsubishiElectric.com/).
- •When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
- •Mitsubishi Electric Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- •The prior written approval of Mitsubishi Electric Corporation is necessary to reprint or reproduce in whole or in part these materials.
- •If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
- Any diversion or re-export contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
- •Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for further details on these materials or the products contained therein.

© MITSUBISHI ELECTRIC CORPORATION